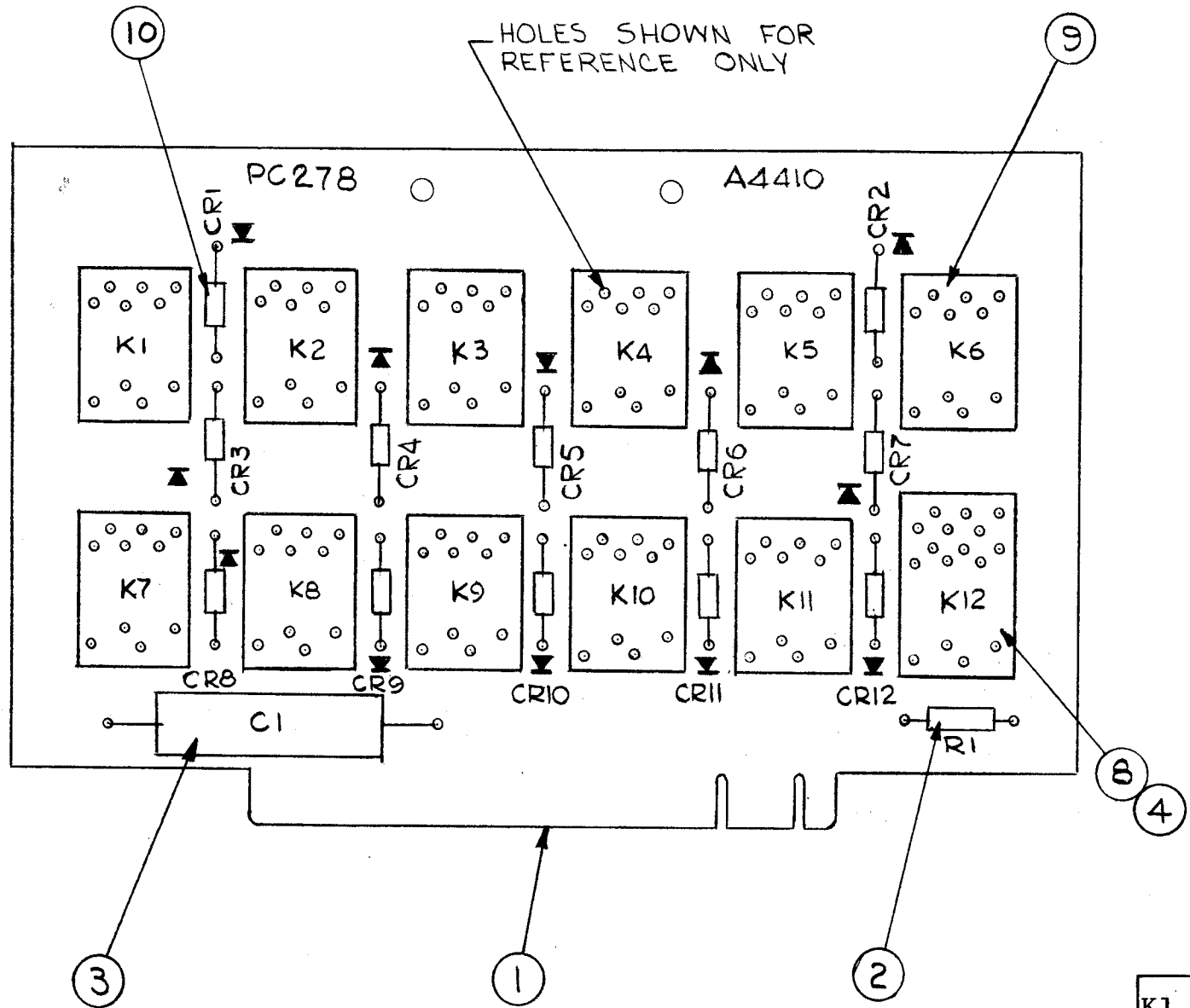


A4410

REVISIONS

SYM	DESCRIPTION	DATE	E.M.N. NO.	DRAFT	CHKD	APPD
X	EXPERIMENTAL RELEASE	9.16.66	X	RME		
Ø	ORIGINAL RELEASE FOR PRODUCTION	9/23/66	Ø	CV		



- ~ ASSEMBLY NOTES ~
- 1- TO MOUNT COMPONENTS, INSERT LEAD THROUGH PLATED THRU-HOLES.
  - 2- (USE CAUTION) WHEN APPLYING HEAT & SOLDER TO LEAD & FOIL.
  - 3- CLEAN & INSPECT AS PER S-676

REQ'D.	ITEM	PART NUMBER	DESCRIPTION	SYMBOL
X	11	BS100	SOLDER, TIN ALLOY	
	12	1N270	SEMICONDUCTOR DEVICE, DIODE	CR1 TO 12
	11	TS171-5	SOCKET, RELAY	
	1	8	TS171-4	
	4	7	RL156-1	K8, 9, 10, 11
	1	6	RL156-4	K7
	6	5	RL156-17	
	1	4	RL156-15	K12
	1	3	CE105-50-50	C1
	1	2	RC20GF132J	R1
	1	1	PC278	PRINTED CIRCUIT BOARD

EATON		LIST OF MATERIAL			
MATERIAL		THE TECHNICAL MATERIEL CORP. MAMARONECK, NEW YORK			
FINISH		TITLE ASSY. PRINTED CIRCUIT BOARD			
UNLESS OTHERWISE SPECIFIED DIMENSIONS ARE IN INCHES AND INCLUDE CHEMICALLY APPLIED OR PLATED FINISHES		DRAWN RME CHECKED <i>[Signature]</i>	DATE 9.16.66 DATE 9/22/66	FINAL APPROVAL <i>[Signature]</i> DATE 9/22/66	DATE 9/22/66
DECIMALS .X ± .05 .XX ± .01 .XXX ± .005	TOLERANCES ± 1/64 ANGLES ± 0° 30'	ELECT. DES. <i>[Signature]</i> MECH. DES.	DATE 9/23/66 DATE	SHEET A4410	REV. LTR.

1	LSCA-1	
Q'TY./UNIT	MODEL USED ON	ASS'Y. NO.
SCALE 1:1	CODE	
THE CONTENTS OF THIS DRAWING ARE THE EXCLUSIVE PROPERTY OF THE TECHNICAL MATERIEL CORP. ITS UNAUTHORIZED USE OR REPRODUCTION IN WHOLE OR IN PART IS STRICTLY FORBIDDEN.		

NOTES